

Helping enable the next generation of electronics.

3M™ EMI/RFI Management Solutions

Don't let unwanted frequencies interfere with electronics components performance.

Why is minimizing EMI/RFI important?

When the amount of noise (EMI) rises higher than the signal's strength, resulting in a low signal-to-noise ratio (SNR), it can degrade electronic performance. This results in errors, data loss, delayed or incorrect readings, or even temporary shutdowns. Which is why it is critical to prevent EMI as much as possible.

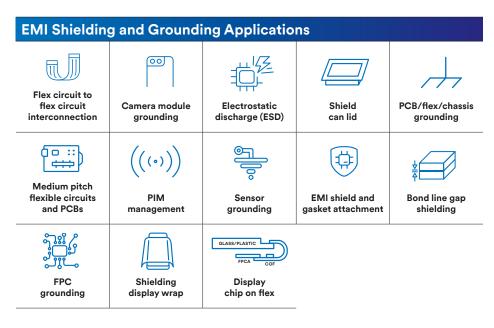
3M[™] EMI/RFI Management Solutions will help you:

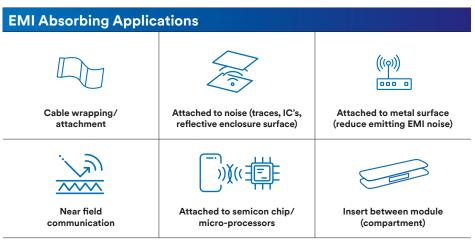
- » Minimize EMI noise and crosstalk
- » Improve signal integrity
- » Enable high performing and reliable materials
- » Be more cost-effective
- » Achieve quick and easy application with peel and stick solutions

Generated by electronic devices, communications signals, electromagnetic frequencies and static electricity, Electromagnetic Interference (EMI) – also known as Radio Frequency Interference (RFI) – is an electronic emission that interferes with the performance of electronic components, RF systems and other critical equipment.

Help manage EMI with 3M™ EMI/RFI Solutions

Help protect your systems and achieve efficient and reliable operations with solutions from 3M. We bring decades of expertise in EMI/RFI management and materials science to help you solve complex and dynamic design challenges. Our EMI/RFI management solutions are known for helping boost signal-to-noise ratios in industrial electronics, improving antenna signal integrity, and even grounding displays for connected and smart products.





3M™ Electrically Conductive Tapes Selection Criteria

Selecting a 3M™ Electrically Conductive Tape for grounding, shielding, and attachment includes identifying several application requirements. For instance, the selection process could consider the following items, among others:

- 1 Contact R target
- 2 Contact surface type
- 3 Adhesion level desired
- 4 Bond line thickness
- 5 XYZ or Z conductivity path
- 6 Operating temperature range and environmental conditions
- 7 EMI shielding in bond line "gap/slit" for higher frequencies
- 8 Surface contact area for adhesion
- 9 Assembly pressure, temperature and time

Meet your "go-to" materials

3M created the EMI/RFI Management Solutions Go-To Material List (GTML) to provide fast and reliable service on our go-to materials. The GTML includes materials that cover most applications and provide differentiated solutions for various EMI design challenges.

Make these materials the first, go-to options for EMI challenges, supplemented by a broader line of 3M EMI/RFI materials for niche applications.

★ = Indicates which select thicknesses are part of the GTML.

The "Good-Better-Best" rankings are based on the 3M Test Method and tape performance in a nominal application.

*This information is based on tests performed at 3M laboratory facilities. While we believe that these test results are reliable, your results may vary due to differences in test conditions, your facility/lab environment, or the other conditions within your control. This information is intended for industrial/occupational use by persons with the knowledge and technical skills to analyze, handle and use such information. It is supplemental only and is not intended to replace the detailed information found in written 3M product literature. For additional information, including important safety and warranty information, regarding 3M EMSD products, please refer to the data sheets, instruction and/or installation manuals.

Product	Typical contact resistance (R ohms Ω)	EMI shielding in bond line gap/slit	Flex to PCB contact resistance (R ohms Ω)	Peel strength (24 hr/RT)	Workability	Thermal conductivity/resistance (W/mK or C/W)
3M [™] Electrically Cor	nductive Double	-Sided Tapes				
3M™ Electrically Conduct	ive Adhesive Transfe	er Tapes				
★ 3M tape 9703	Good	N/A	Better	Good	Good	Good
3M tape 9709SL	Better	Better	Best	Good	Better	Best
3M tape 9712	Good	Good	Good	Better	Good	Good
3M tape 9713	Better	Good	Good	Better	Good	Good
3M tape 9719	Good	Good	Good	Good = Std.	Good	Good
Sivi tape 97 19	Good	Good	Good	Best = LSE	Good	Good
3M [™] Electrically Conduct	ive Double-Coated	Tapes				
★ 3M tape 5113DFT	Best	Best	Best	Better	Best	Better
3M tape 9772	Best	Best	Good	Good	Best	Best
3M tape 9711S	Best	Better	Best	Best	Best	Better
3M tape 9750	Better	Better	Better	Best	Better	Good
3M [™] Electrically Cor	nductive Single-	Sided Tapes				
★ 3M tape 5113SFT	Better	Good	Better	Good	Better	Good
3M tape 3304BC-S	Best	Best	Best	Better	Better	Good
3M tape 1020BC	Best	Better	Best	Good	Best	Better
★ 3M tape 1050TC	Best	Better	Best	Good	Better	Best
3M tape CEF-3BV	Good	Good	Good	Better	Better	Good

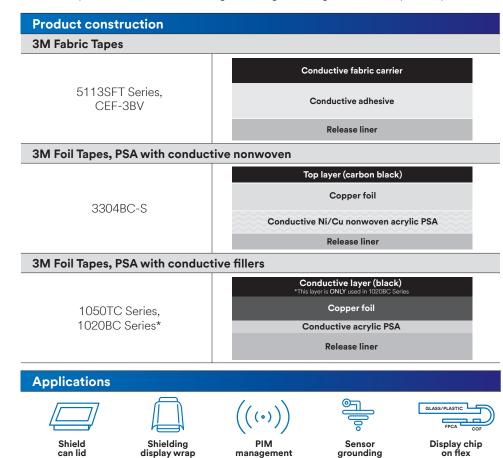
- » Typical contact resistance Gold flex bonded to stainless steel (SS). "Best" results relate to a lower contact R potential on SS Contact R can vary with SS type tested. Lower contact resistance can allow for improved EMI shielding of a design.
- » EMI Shielding in Bond Line "Gap/Slit" Best = High dB EMI Shielding. Inherent EMI shielding at the bond line provides significantly reduced crosstalk, stray EMI, noise in circuit, antennae effects, FPC susceptibility and spurious emissions.
- » Flex to PCB Contact Resistance Potential to improve contact R grounding locations via improved surface conformability and XYZ conductive potential with a 3M electrically conductive tape or film vs. a generic Z-axis only conductive PSA.
- » Peel Strength Adhesion to SS type substrate/3M Test Method/24 hour room temp dwell.
- Workability Ease of Rework based on a standard set of high surface energy substrates. The tape design can affect rework based on adhesive type and conductive filler type.
- » Thermal Conductivity/Thermal Resistance Effective Thermal Resistance and Thermal Conductivity vs. a generic PSA without conductive fillers. Important for thermal connection performance between substrates.

3M™ Electrically Conductive Single-Sided Tapes

3M™ Electrically Conductive Single-Sided Tapes offer XYZ-axis conductivity in a variety of conductive adhesives, carriers, and fillers to provide enhanced EMI performance where you need it (flexibility, conformability, adhesion, temperature range, etc.). These tapes are available in multiple thicknesses and provide EMI/RFI shielding and/or grounding across multiple frequencies.

Features and benefits

- » XYZ-axis conductivity
- » Conformability and edge conformance
- » Excellent EMI/ESD and electrical performance over time
- » Overlap resistance and electrical contact on small areas and bond lines
- » High adhesion for reliable contact to various substrates
- » Great handling& workability
- Thin product constructions for applications with less Z-space



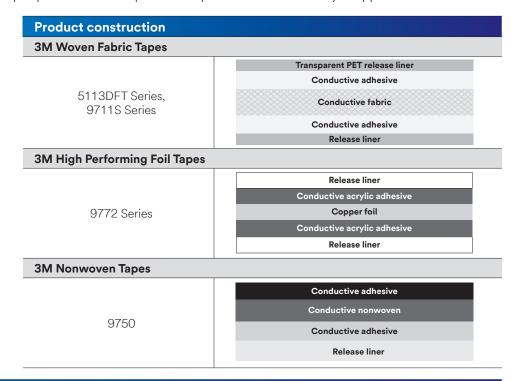
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3M product number	Thickness mil (mm)	Conductive filler type and tape format	Adhesive type	Liner type	Electrical resistance through Z-axis Ω (3M ETM-12)	Electrical resistance through XY-axis Ω (3M ETM-7)	Adhesion to SUS (gf/inch)	Unique features and benefits
★ 5113SFT	2.0 (0.05)	Fabric backing C-SFT	Polyolefin	PET release liner	<0.03 Ω	<0.1 Ω	1500 (ASTM D3330)	 XYZ-axis conductivity through adhesive Excellent electrical contact to small size areas Resists moisture to maintain the products' integrity enabling a 4-year shelf-life Excellent EMI shielding in bond line gap Expands long-term operating temperature range to 105°C
3304BC-S	1.8 (0.45)	Ni/Cu nonwoven foil backing		Silicone coated PET film	0.05 Ω	0.1 Ω	1300 (ASTM D1000)	» Scratch-resistant black copper foil» Excellent edge conformability» High shielding performances
★ 1050TC	0.9 (0.023)	Foil backing C-SCT		PET release liner	e N/A	0.015 Ω	1200 (ASTM D1000)	» XYZ-conductivity» Conformable, quick bonding» Copper foil backing
1020BC	1.0 (0.025)	Foil backing C-SCT	Acrylic			0.015 Ω	1300 (ASTM D1000)	XYZ-conductivity Excellent EMI shielding performance Excellent conformability and quick bonding Reliable contacts to small size grounding areas High adhesion and good grounding performance to many surface types Black conductive coating
CEF-3BV	2.8 (0.07)	Black fabric backing C-SFT		Paper liner		0.4 Ω	1300 (ASTM D1000)	Scratch resistance Black fabric tape High reliability for Auto Electrification market Liquid Crystal Modules (LCM) wrapping

3M™ Electrically Conductive Double-Coated Tapes

3M™ Electrically Conductive Double-Coated Tapes feature XYZ-axis conductivity and have a layer of adhesive coated on both sides of the carrier and are easier to die-cut and handle than adhesive transfer tapes (no carrier). They come in a variety of conductive adhesives, carriers and fillers to provide enhanced EMI performance where you need it (flexibility, conformability, adhesion, temperature resistance). The tapes provide a broad spectrum of performance in a variety of applications.

Features and benefits

- » XYZ-axis conductivity
- » A broad range of thicknesses
- » Electrical contact to small contact areas and bond lines
- » Excellent grounding performance over time
- » Great EMI shielding in bond line gap
- » Multiple levels of adhesion, conformability, and flexibility
- » Adhesion to a variety of substrates and surfaces
- » Great handling & workability



Applications



Flex circuit to flex circuit interconnection



Sensor grounding



Electrostatic discharge (ESD)



EMI shield and gasket attachment



PCB/flex/ chassis grounding



Flexible circuits and PCBs



FPC grounding

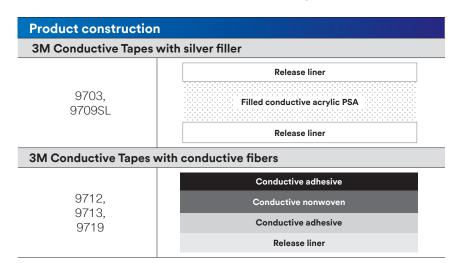
3M product number	Thickness mil (mm)	Conductive filler type and tape format	Adhesive type	Liner type	Electrical resistance through Z-axis Ω (3M ETM-12)	Electrical resistance through XY-axis Ω (3M ETM-7)	Adhesion to SUS (gf/inch)	Unique features and benefits
★ 5113DFT	2.0 (0.05)	Fabric backing	Polyolefin		0.03 Ω	0.1 Ω	1500 (ASTM D3330)	XYZ-axis conductivity through adhesive Excellent electrical contact to small size areas Resists moisture to maintain the products' integrity enabling a 4-year shelf-life Excellent EMI shielding in bond line gap Expands long-term operating temperature range to 105°C
9772	1.2 (0.03), 2 (0.05)	Foil backing		PET release liner	N/A	0.015 Ω	1000 (ASTM D1000)	Good EMI shielding in the bondline gap Best XY-axis electrical resistance in double-sided conductive PSAs Low PIM
9711S	2 (0.05)	Ni/Cu woven	Acrylic		0.05 Ω	0.15 Ω	1800 (ASTM D1000)	 » Low contact resistance » High adhesion » Excellent conformability » Quick bonding » Wide range of thickness options
9750	2.1(0.55)	Ni/Cu PET nonwoven		Paper liner	0.07 Ω	_	Face 1300 Back 1800 (ASTM D3330)	» High adhesion » Lower resistance nonwoven conductive scrim

3M™ Electrically Conductive Adhesive Transfer Tapes

3M™ Electrically Conductive Adhesive Transfer Tapes deliver a broad spectrum of performance, including high EMI shielding in the bond line gap for high-frequency attenuation, stable contact resistance for reliable electrical conductivity, and conformability for creating a strong bond. Multiple thicknesses, conductive fillers, and particle designs are available.

Features and benefits

- » XYZ-axis conductivity or Z-axis based conductivity
- » A broad range of thicknesses
- » Electrical contact to small contact areas and bond lines
- » Excellent grounding performance over time
- » Great EMI shielding in bond line gap
- » Multiple levels of adhesion, conformability, and flexibility
- » Adhesion to a variety of substrates and surfaces
- » Great handling & workability



Applications





















Flex circuit to flex circuit interconnection

Camera module grounding **Electrostatic** discharge (ESD)

EMI shield and gasket attachment PCB/flex/ chassis grounding

Medium pitch flexible circuits and PCBs

grounding

Sensor grounding

Bond line gap shielding

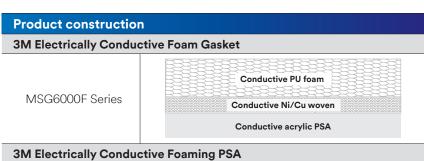
3M product number	Thickness mil (mm)	Conductive filler type	Adhesive type	Liner type	Electrical resistance through Z-axis Ω (3M ETM-12)	Electrical resistance through XY-axis Ω (3M ETM-7)	Adhesion to SUS (gf/inch)	Unique features and benefits		
★ 9703		Cilor	Acrylic	Silicone treated PCK	0.01 Ω	N/A	907 (ASTM D1000)	» Anisotropic Z-axis electrical conductivity » Low outgassing » Pressure-sensitive adhesive (PSA) tack properties » Thermal curing not required		
9709SL	(0.05)	Silver particles		PCK release liner, PET release liner	0.06 Ω	40 Ω	825 (ASTM D1000)	 » Standard adhesion » Good EMI shielding in bond line gap » High frequency » Thermal conductivity » Excellent conformability » Low liner release (SL) 		
9712	5 (0.127)	Carbon nonwoven		Silicone treated	13 Ω	50-70 Ω	1500 (ASTM	» Standard adhesion » No nickel » Non-magnetic material » Nonwoven conductive scrim		
9713	3.5 (0.089)	Ni/Cu				PCK	1.7 Ω	5 Ω	D3330)	Standard adhesion Isotropic XYZ-axis electrical connectivity Uses nickel plated carbon scrim Good contact with both hard and soft surfaces Excellent die-cutting and converting capabilities
9719	4 (0.1)	nonwoven	Silicone	Dual PET liners	10 Ω	15-30 Ω	850 (ASTM D3330)	 » Good adhesion to LSE substrate » Best peel strength for LSE materials » Good peel strength for standard products » Higher temperature resistance 149–204°C 		

3M™ Electrically Conductive Gasket Tapes

3M™ Electrically Conductive Gasket Tapes are compressible electrically conductive open-cell urethane foam gaskets with single or double-coated conductive adhesives and an additional internal copper foil layer for shielding gaskets (3M™ Tape MSG6000F Series). These XYZ-axis conductive gaskets feature excellent conductivity to ground two surfaces with a wide gap and/or EMI shielding.

Features and benefits

- » Multiple thickness options for a range of gap sizes
- » Grounding connection under compression
- » Reworkable during assembly
- » Single or double-coated conductive adhesive
- » Conductive foam laminated with fabric allows compression for very wide gaps (3M™MSG600F series)
- » High adhesion conductive acrylic pressure sensitive
- » Removable liner for easy handling and die-cutting
- » Halogen-free products available



ECG7000H Series, ECG8000H Series*



Applications



grounding



discharge (ESD)



Bond line gap shielding

3M product number	Thickness mil (mm)	Carrier type	Conductive filler type	Adhesive type	Liner type	Operating temp °C	Unique features and benefits
MSG6030F	11.8 (0.3)	Foam	Polyurethane				» Single side conductive adhesive
MSG6060F	23.6 (0.6)	laminated with conductive fabric	plated with Cu/Ni	Acrylic	PET liner	ST 121°C, LT 85°C	» Highly compressible, ex. MSG-7100» Metal plated
MSG6100F	40 (1.0)		(foam)				» Open cell urethane
ECG7033H	13 (0.33)		Ni		PE coated paper liner	ST 125°C, LT 80°C	 » Single side conductive adhesive, ex. ECG-7033H » Metal plated » Open cell urethane » Double side conductive adhesive, ex. ECG-8035H » Metal plated » Open cell urethane
ECG7053H	20.8 (0.53)						
ECG7073H	28.7 (0.73)	Plated					
ECG8035H	13.8 (0.35)	polyurethane foam					
ECG8055H	21.6 (0.55)						
ECG8075H	29.5 (0.75)						

3M™ EMI Absorbers

3M™ EMI Absorbers are flexible composite materials incorporating specialized magnetic particles and a non-conductive PSA to absorb EMI. These absorbers help protect nearby electronics from EMI by absorbing EMI at multiple frequencies. 3M absorbers offer high permeability and magnetic loss in many target frequency ranges. They are used in a wide range of applications to help reduce EMI/RFI noise and improve signal integrity that could interfere with a system's operations.

Features and benefits

- » Absorbing capabilities up to 6GHz with targeted permeability
- » Absorbing performance is thickness dependent (ex. 100MHz to 4GHz for 3M absorber EM25TP)
- » Helps improve antenna performance and reduce EMI interference within a device
- » Multiple thickness options for diverse applications
- » Supplied on a removable liner for easy handling
- » Halogen free products available

Product construction 3M Composite EMI Absorber EM25TP Series, MFC-1H Target frequency: 500MHz - 4GHz AB5000HF Series, AB5000SHF Series Target frequency: 1GHz AB7000HF Series Target frequency: 1GHz - 2GHz AB1000 Series Target frequency: 4GHz - 6GHz

3M Hybrid Shielding EMI Absorber

AB6005HF (AL+PET), AB6005SHF (PET+AL+PET)

AL-PET layer
Absorber
Acrylic adhesive
Release liner

Applications



Cable wrapping/ attachment



Attached to semicon chip/micro-processors



Insert between module (compartment)



Attached to noise (traces, IC's, reflective enclosure surface)

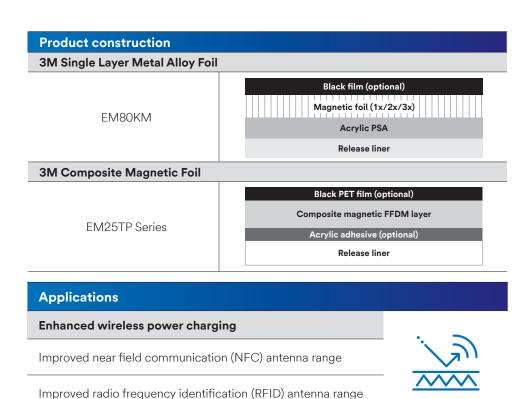
	3M product number	Thickness mil (mm)	Adhesive	Initial permeability @1MHz or 3MHz [μ']	Operating frequency MHz-GHz	Operating temp range (°C)	Unique features and benefits
*	EM25TP-005-A10, EM25TP-0100-A10, EM25TP-0200-A20	2 (0.05), 4 (0.1), 8 (0.2)	Acrylic	250	100MHz - 4GHz	-25 ~ 90°C	 » Broad frequency absorber » High permeability magnetic film » Absorbing performance100MHz – 4GHz » Targeted permeability for magnetic shielding < 5MHz – 10MHz
	AB1030, AB1050	13 (0.33), 20 (0.53)	Acrylic conductive PSA	25 @ 3MHz	2GHz – 6GHz	-25 ~ +100°C	 » High performance at high frequency (several GHz) » Improved performance vs the 3M absorber AB7000HF in the 3-6GHz range
*	AB7010HF, AB7020HF, AB7030HF, AB7050HF	5.2 (0.13), 9.8 (0.25), 14 (0.35), 22 (0.55)	Acrylic	110	500MHz – 4GHz	-25 ~ 85°C	 Good workability High resistivity High permeability Improved lower frequency absorber vs the AB5000 series (@ <1 GHz)
	AB5010HF/SHF, AB5020HF/SHF, AB5030HF/SHF, AB5050HF/SHF, AB5100HF/SHF	4 (0.1), 8 (0.2), 12 (0.3), 19.5 (0.5)	non- conductive PSA	55 HF, 30 SHF	100MHz – 3.5GHz	-25 ~ 85°C	 » AB5000HF: Standard absorber » AB5000SHF: Advanced EMI absorber, lower peak absorber frequency than AB5000HF, thermal conductivity 0.7 W/m-K
	AB6005SHF	4 (0.1)		30 – 250	10MHz – 18GHz	-30 ~ +105°C	» EMI metal shielding layer and absorption layer
	MFC-1H	19.5 (0.5)	Silicone	110 –130 @ 3MHz	10MHz – 4GHz	-40 ~ 150°C	High performance resin system stable under solder reflow conditions Higher temperature range than other 3M absorbers

3M™ Magnetic Shielding Materials

3M™ Magnetic Shielding Materials are thin magnetic materials that interact and influence electro-magnetic (EM) fields. These materials help protect sensitive electronic components and circuitry by shielding external low magnetic fields (<1MHz). Magnetic shielding materials "capture" the magnetic field and isolate the interference. The high magnetic permeability and low magnetic loss helps enable flux field redirection for applications less than 20MHz.

Features and benefits

- » High permeability magnetic foil
- » Low and resistivity options
- » Good workability
- » Approximately 80,000 permeability dependent on product and thickness
- » Thin overall construction
- » Pressure sensitive acrylic tape for high adhesion
- » Supplied on a removable liner for easy removal



	3M product number	Total I thickness mil (mm)		Adhesive type	Permeability (u')	Operating temp range (°C)	Unique features and benefits	
	3M [™] Flux Field Directional Material EM80KM	2 (0.05)	Soft magnetic foil, nanocrystalline	Acrylic PSA	Max 80,000	-25 ~ 110°C	» Low frequency focused for magnetic field » High permeability magnetic foil » Thin overall product construction allows for thinner design	
-	EM25TP-005-A10, EM25TP-100-A10, EM25TP-0200-A20	2 (0.05), 4 (0.1), 8 (0.2)	Soft magnetic composite	Acrylic PSA	250	-	Broad frequency absorber High permeability magnetic film Absorbing performance 100MHz - 4GHz Targeted permeability for magnetic shielding <5MHz - 10MHz	



Contact your 3M sales representative or visit 3m.com/electronicsassembly to learn more.

Regulatory: For regulatory information about this product, contact your 3M representative.

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